

**Application Data Sheet**

**APPLICATION INFORMATION**

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?:

Computer Readable Form (CRF)?:: No

Number of Copies of CRF::

Title:: CLEANING COMPOSITION FOR REMOVING  
RESISTS AND MANUFACTURING METHOD OF  
SEMICONDUCTOR DEVICE

Attorney Docket Number:: 402696

Request for Early Publication?: No

Request for Non-Publication?: No

Suggested Drawing Figure::

Total Drawing Sheets:: 6

Small Entity?: No

Latin Name::

Variety denomination name::

Petition Included?: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?: No

## APPLICANT INFORMATION

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Itaru  
Middle Name::  
Family Name:: KANNO  
Name Suffix::  
City of Residence:: Hyogo  
State or Prov. of Residence::  
Country of Residence:: Japan  
Street of mailing address:: c/o Renesas Technology Corp.  
4-1, Marunouchi 2-chome, Chiyoda-ku  
City of mailing address:: Tokyo  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 100-6334

Inventor Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Yasuhiro  
Middle Name::  
Family Name:: ASAOKA  
Name Suffix::  
City of Residence:: Hyogo  
State or Prov. of Residence::  
Country of Residence:: Japan  
Street of mailing address:: c/o Renesas Technology Corp.  
4-1, Marunouchi 2-chome, Chiyoda-ku  
City of mailing address:: Tokyo  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 100-6334

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Masahiko  
Middle Name::  
Family Name:: HIGASHI  
Name Suffix::  
City of Residence:: Hyogo  
State or Prov. of Residence::  
Country of Residence:: Japan  
Street of mailing address:: c/o Renesas Technology Corp.  
4-1, Marunouchi 2-chome, Chiyoda-ku  
City of mailing address:: Tokyo  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 100-6334

Inventor Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Yoshiharu  
Middle Name::  
Family Name:: HIDAKA  
Name Suffix::  
City of Residence:: Osaka  
State or Prov. of Residence::  
Country of Residence:: Japan  
Street of mailing address:: 5-40-7, Nanpeidai  
City of mailing address:: Takatsuki-shi  
State or Province of mailing address:: Osaka  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 569-1042

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Etsuro  
Middle Name::  
Family Name:: KISHIO  
Name Suffix::  
City of Residence:: Kyoto  
State or Prov. of Residence::  
Country of Residence:: Japan  
Street of mailing address:: 202, Annex Kotobuki  
24-1, Fukakusaharaigawa-cho, Fushimi-ku  
City of mailing address:: Kyoto-shi  
State or Province of mailing address:: Kyoto  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 612-0013

Inventor Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Tetsuo  
Middle Name::  
Family Name:: AOYAMA  
Name Suffix::  
City of Residence:: Kanagawa  
Country of Residence:: Japan  
Street of mailing address:: c/o EKC Technology K. K.  
R&D Business Park Building D-3F  
2-1, Sakado 3-chome, Takatsu-ku  
City of mailing address:: Kawasaki-shi  
State or Province of mailing address:: Kanagawa  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 213-0012

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Tomoko  
Middle Name::  
Family Name:: SUZUKI  
Name Suffix::  
City of Residence:: Kanagawa  
Country of Residence:: Japan  
Street of mailing address:: c/o EKC Technology K. K.  
R&D Business Park Building D-3F  
2-1, Sakado 3-chome, Takatsu-ku  
City of mailing address:: Kawasaki-shi  
State or Province of mailing address:: Kanagawa  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 213-0012

Inventor Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Toshitaka  
Middle Name::  
Family Name:: HIRAGA  
Name Suffix::  
City of Residence:: Kanagawa  
Country of Residence:: Japan  
Street of mailing address:: c/o EKC Technology K. K.  
R&D Business Park Building D-3F  
2-1, Sakado 3-chome, Takatsu-ku  
City of mailing address:: Kawasaki-shi  
State or Province of mailing address:: Kanagawa  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 213-0012

Inventor Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Toshihiko
Middle Name::	
Family Name::	NAGAI
Name Suffix::	
City of Residence::	Kanagawa
State or Prov. of Residence::	
Country of Residence::	Japan
Street of mailing address::	c/o EKC Technology K. K. R&D Business Park Building D-3F 2-1, Sakado 3-chome, Takatsu-ku
City of mailing address::	Kawasaki-shi
State or Province of mailing address::	Kanagawa
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	213-0012

## **CORRESPONDENCE INFORMATION**

Correspondence Customer Number::	23548
Phone::	(202) 737-6770
Fax::	(202) 737-6776
E-mail Address::	dcmail2@leydig.com

## **REPRESENTATIVE INFORMATION**

Representative Customer Number:: 23548

Representative Designation::                      Registration Number::                      Representative Name::

## **DOMESTIC PRIORITY INFORMATION**

Application::                      Continuity Type::                      Parent Application::                      Parent Filing Date::

## **FOREIGN APPLICATION INFORMATION**

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2002-203987	07/12/02	Yes
Japan	2003-174816	06/19/03	No

## ASSIGNEE INFORMATION

Assignee name::               Renesas Technology Corp.

Street of mailing address:: 4-1, Marunouchi 2-chome  
Chiyoda-ku

City of mailing address::   Tokyo

State or Province of  
mailing address::

Country of mailing  
address::                   Japan

Postal or Zip Code of  
mailing address::           100-6334

Assignee name::               Matsushita Electric Industrial Co., Ltd.

Street of mailing address:: 1006, Oaza Kadoma

City of mailing address::   Kadoma-shi

State or Province of  
mailing address::           Osaka

Country of mailing  
address::                   Japan

Postal or Zip Code of  
mailing address::           571-8501

Assignee name::               EKC Technology K. K.

Street of mailing address:: R&D Business Park Building D-3F  
2-1, Sakado 3-chome, Takatsu-ku

City of mailing address::   Kawasaki-shi

State or Province of  
mailing address::           Kanagawa

Country of mailing  
address::                   Japan

Postal or Zip Code of  
mailing address::           213-0012